

RACK LEVEL HIGH DENSITY LIQUID COOLING

Data center density is increasing and cooling technology is facing steep challenges. Traditional air cooling is no longer sufficient, while using all liquid cooling is too costly and inflexible for most operations. Hybrid cooling combines direct-to-chip liquid cooling with air cooling to deliver significant benefits in the near term, and flexibility to scale up in the future.

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This white paper presents a rack level Hybrid Liquid Cooling System that couples direct-contact liquid cooling with a rear door cooler air-to-water heat exchanger.

The rack-level Hybrid Liquid Cooling System presents a unique entry point to achieving much higher efficiencies of liquid cooling as well as built-in components that provide flexibility and scalability for attaining additional efficiencies long term.



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